

# SPC5777CLK3MME3

### SPC5777CLK3MME3 Information



For Reference Only

Part Number SPC5777CLK3MME3

Manufacturer NXP

Category Integrated Circuits (ICs)

Embedded - Microcontrollers

**Description** NXP 32-BIT MCU POWER ARCH CORES

Package 416-BGA

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

## **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









### **SPC5777CLK3MME3 Specifications**

Supplier Device Package	416-MAPBGA (27x27)	
Package / Case	416-BGA	
Mounting Type	-	
Operating Temperature	-40°C ~ 125°C (TA)	
Oscillator Type	Internal	
Data Converters	A/D 16b Sigma-Delta, eQADC	
Voltage - Supply (Vcc/Vdd)	3 V ~ 5.5 V	
RAM Size	512K x 8	
EEPROM Size	-	
Program Memory Type	FLASH	
Program Memory Size	8MB (8M x 8)	
Number of I/O	-	
Peripherals	DMA, LVD, POR, Zipwire	
Connectivity	CANbus, EBI/EMI, Ethernet, FlexCANbus, LINbus, SCI, SPI	
Speed	264MHz	
Core Size	32-Bit Tri-Core	
Core Processor	e200z7	
Series	MPC57xx	
Package	416-BGA	
	Embedded - Microcontrollers	
Category	Integrated Circuits (ICs)	
Manufacturer	NXP	
Manufacturer Part Number	SPC5777CLK3MME3	

#### SPC5777CLK3MME3 Guarantees



#### **Quality Guarantees**

We provide 90 days warranty. \*

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

### **SPC5777CLK3MME3 Payment Methods**



















### SPC5777CLK3MME3 Shipping Methods













If you have any question about SPC5777CLK3MME3, please do not hesitate to contact us!

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